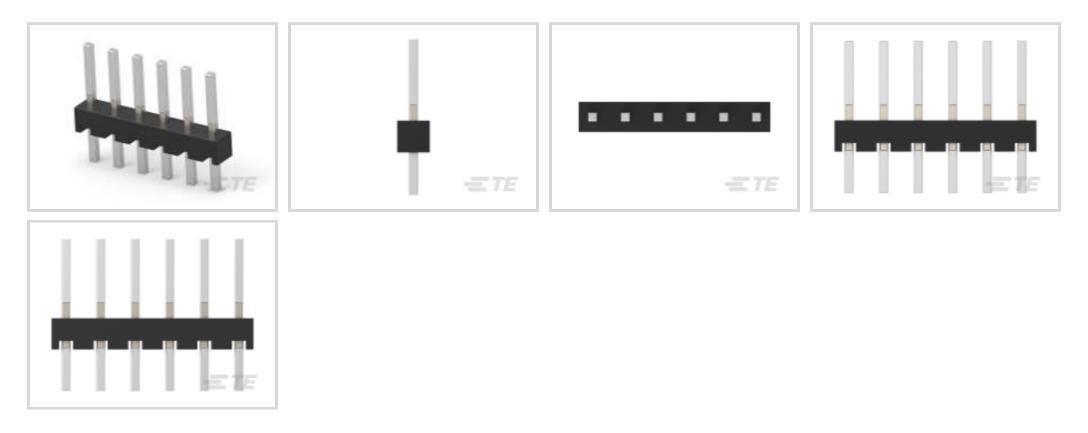


AMPMODU | AMPMODU Headers

TE Internal #: 5-146278-6 PCB Mount Header, Vertical, Board-to-Board, 6 Position, 2.54 mm [. 1 in] Centerline, Breakaway, Tin, Through Hole - Solder, Signal, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 6

Number of Rows: 1

Features

E TE

Product Type Features

PCB Connector Assembly Type	PCB Mount Header			
Connector System	Board-to-Board			
Header Type	Breakaway			
Sealable	No			
Connector & Contact Terminates To	Printed Circuit Board			
Configuration Features				
Connector Contact Load Condition	Fully Loaded			
PCB Mount Orientation	Vertical			
Number of Positions	6			
Number of Rows	1			
Board-to-Board Configuration	Parallel			
Electrical Characteristics				
Operating Voltage	30 VAC			
Body Features				

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Connector Profile	Standard			
Primary Product Color	Black			
Contact Features				
Mating Square Post Dimension	.64 mm[.025 in]			
	100 – 200 µin			
Contact Shape & Form	Square			
Contact Underplating Material	Nickel			
PCB Contact Termination Area Plating Material	Tin			
Contact Base Material	Phosphor Bronze			
Contact Mating Area Plating Material	Tin			
Contact Mating Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]			
Contact Type	Pin			
Contact Current Rating (Max)	3 A			
Termination Features				
Square Termination Post & Tail Dimension	.64 mm[.025 in]			
Termination Post & Tail Length	3.05 mm[.12 in]			
Termination Method to Printed Circuit Board	Through Hole - Solder			

Mechanical Attachment

Mating Alignment	Without		
PCB Mount Retention	Without		
PCB Mount Alignment	Without		
Connector Mounting Type	Board Mount		
Housing Features			
Centerline (Pitch)	2.54 mm[.1 in]		
Housing Material	LCP (Liquid Crystal Polymer), LCP-GF (Liquid Crystal Polymer)		
Dimensions			
PCB Thickness (Recommended)	1.57 mm[.062 in]		
Usage Conditions			
Housing Temperature Rating	High		
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]		
Operation/Application			

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Solder Process Feature	Board Standoff			
Circuit Application	Signal			
Industry Standards				
Approved Standards	CSA LR7189, UL E28476			
UL Flammability Rating	UL 94V-0			
Packaging Features				
Packaging Quantity	240			
Packaging Type	Carton			
Product Compliance For compliance documentation, visit the product page on TE.com>				
EU RoHS Directive 2011/65/EU	Compliant			
EU ELV Directive 2000/53/EC	Compliant			
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold			
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC			

Halogen Content

Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free

Pin-in-Paste capable to 260°C

Solder Process Capability

Product Compliance Disclaimer

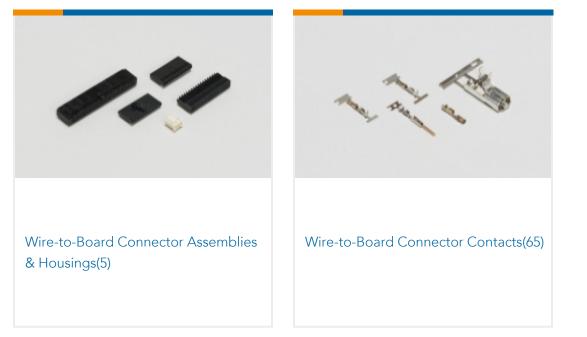
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Also in the Series | AMPMODU Headers

PCB Mount Header, Vertical, Board-to-Board, 6 Position, 2.54 mm [.1 in] Centerline, Breakaway, Tin, Through Hole - Solder, Signal, AMPMODU Headers







Customers Also Bought



TE Part #3-643814-6 06P MTA100 CONN ASSY POL RIB	TE Part #5535089-5 ASSEMBLY,RECEPTACLE,EUROCARD, T	TE Part #1761681-1 IDC LOW PRO HDR 6P VERT HT BLACK	TE Part #1-770875-1 06P MINI UMNL HDR ASSY AU LF
ETE	• F	E TE	TE
TE Part #640445-9 09P MTA156 HDR ASSY FL/STR SN	TE Part #1586055-1 VAL-U-LOK SKT BR SN 16AWG	TE Part #1-1879216-0 CPF 0402 61K9 0.1% 25PPM 1K RL	TE Part #1825059-5 ADF02ST04=DIP SWT,FLUSH,SMT-GW



Documents

PCB Mount Header, Vertical, Board-to-Board, 6 Position, 2.54 mm [.1 in] Centerline, Breakaway, Tin, Through Hole - Solder, Signal, AMPMODU Headers



CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5-146278-6_E.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5-146278-6_E.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5-146278-6_E.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance

TE Material Declaration

English